

## Electronic Traveller (eMIP)

A transparent tool for production monitoring

Matthias Bonora TE-MSC-TM

On behalf of MSC-QA team Olivier Housiaux, Rosario Principe, Kevin Monneron Support of EN-IM team

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## Outline

- What is a MIP
- Motivation and objectives
- Implementation
- Building an eMIP
- Future plans and features



## What is a MIP

- Reference document to ensure that manufacturing was properly done
- Lists manufacturing steps, inspection steps, and versions of procedures/drawings used for production
- Implemented at CERN for HL-LHC project
- From nuclear industry (complex, reliable)



### **MIP Example**

| (D) |   | PROJECT                                     |   |                     |            |  |      |  |  |   | EDMS NO.<br>1582708<br>REFERENCE: | REV<br>4.0   | 7. VALIDITY<br>RELEASED<br>BH_C-FP-0007 |
|-----|---|---|---|---------------------|------------|--|------|--|--|---|-----------------------------------|--------------|---|
| No  | ACTIVITY / OPÉRATION  | APPL.<br>STANDAR<br>DS /<br>NORMES<br>APPL. | APPLICABLE<br>DOCUMENTS /<br>DOCUMENTS<br>APPLICABLES   | REV.<br>DOC.        | Co<br>(Col | ontractor's QA/QC<br>ntract Number S197)<br>Signature/Date   | Code | INSPECTION /<br>CERN/ CHECK<br>(LIMF-QA)<br>Signature/Date | CONTRÔ<br>3 <sup>RD</sup> PAI<br>(<br>Code | LE<br>RTY/SURVEILLANCE<br>WPL or WPE)<br>Signature/Date | INSPECTION<br>REPORT              | REV.<br>DOC. | NOTES /<br>COMMENTAIRES                 |
| в   | COMPONENTS<br>PRÉPARATION DES SOUS<br>COMPOSANTS              | (   |   |                     | (          |  | ſ    | -Burney and  | ſ  | orginator of oute                                       | $\square$                         |              |   |
| B.1 | Prepare the components<br>Préparer les sous<br>composants     |   | Procedure LHC-<br>MBH_C-FP-0003<br>Control LHC-<br>MBH_C-FP-0006<br>File LHC-MBH_C-<br>FP-0014                            | 7.0<br>0.4<br>6.0   | R          | ANDAEINI<br>Richel<br>17/05/10                               |      |  |  |   |                                   |              |   |
| с   | WINDING / BOBINAGE  |   |   |                     |            | /  |      |  |  |   |                                   |              |   |
| C.1 | Winding of the inner layer<br>Bobiner la couche interne       |   | Procedure LHC-<br>MBH_C-FP-0003<br>Drawing<br>LHCMBH_C0011<br>Control LHC-<br>MBH_C-FP-0006<br>File LHC-MBH_C-<br>FP-0014 | 7.0<br>A<br>0.4     | H/R        | ANDREIN ;<br>Michel<br>17/05/18                              | -    |  |  |   | 1975154                           |              |   |
| C.2 | Curing of the inner layer<br>Polymériser la couche<br>interne |   | Procedure LHC-<br>MBH_C-FP-0004<br>Control LHC-<br>MBH_C-FP-0006<br>File LHC-MBH_C-<br>FP-0014                            | 6,0                 | H/R        | ANOREINI<br>nichel<br>23/05/19                               | w    | HOUSIAUX<br>22/05/19<br>RAS                                |  |   | 1976615                           |              |   |
| с.з | Winding of the outer layer<br>Bobiner la couche externe       |   | Procedure LHC-<br>MBH_C-FP-0003<br>Drawing<br>LHCMBH_C0012<br>Control LHC-<br>MBH_C-FP-0006<br>File LHC-MBH_C-<br>FP-0014 | 7.0<br>A 0.4<br>6.0 | H/R        | Chubault<br>GENESTIER<br>Berestier<br>Berestier<br>Berestier |      |  |  |   | 1981858                           |              |   |
|     |   |   |   |                     |            |  |      |  |  |   |                                   |              |   |
| Des | cription of the operation                                     | Do  | ocumentat   | ion                 | ١          | /alidation   |      | CERN   | 3  | <sup>rd</sup> party<br>(if any)                         | Reports                           |              | Additional<br>Comments                  |
|     |   |   | traceability  | у                   |            |  |      | Controls   |  |   |                                   | ©            | Olivier Housiau                         |



What is a MIP

#### 2022-07-21

## MIP in field

- Follows the production
- "Travels" with the assembly







## Motivation for electronic MIP

- Paperless CERN
  - Traceability, security, accessibility
  - GL + TE-MSC-QA initiative
- Propagation of changes
  - Direct access to latest version of procedure, drawings and follow-up file
  - Automatic data recording
  - Notifications
- Data analysis
  - KPIs, summaries, as needed

•  $\rightarrow$  Introducing the eMIP



## **Objectives - Technical**

- Robust
- Simple in administration
- Flexible and secure
- Adaptable to requirements from production & management.
- Using CERN infrastructure (EAM, EDMS)
  - Support from EAM team
- Generic
  - Avoid customization for each eMIP
  - benefit for other teams



## **Objectives - User**

- Access to documentation during production
  - procedures, drawings, checklists, manuals, standards
- Access to documentation as used during assembly (back engineering)
- Digitally signing of performed steps
- Integrated checklists



# **Objectives - Management**

- Real-time access to current state of production
- Traceability of responsibilities with signatures
- Notification on milestone steps
- Summary reports, KPIs





# Implementation - eMIP



#### EAM/EDMS/MTF

- A collection of reports, tools and features
- A recipe for creating Workorders, Taskplans and Checklists



Implementatior



## eMIP Technologies Used

- EAM/MTF
  - Production steps and checklists
  - EAMLight as user interface in field
- Pentaho
  - Report generation
- EDMS
  - Storing and referencing documents

EN-IM team support

• No custom software (within TE-MSC)





## eMIP Hardware

- Dedicated hardware station
  - Computer, touchscreen, barcode scanner
- Or Tablet / Phone
  - EAMLight mobile support







# First Step – Prototyping (2021)

- Technical concept and prototyping
  - Test stations for hardware
- Implementation of all features
  - Holding points, blocking points,
  - E-signing,
  - Custom reports
  - Notifications



# Prototyping – Lessons Learned

- Too much hardcoding and customization
  - Not robust, hard to administer, hard to change, hard to maintain
- Be aware of complexity
  - Hard to track errors and permission problems
- Blocking points are dangerous
  - Stops work on eMIP until issue is resolved
  - Use procedural holding points instead of technical ones
- Better simple and working than complex and breaking
- Need to keep everyone involved



## New Version – "Production"

- Take what worked from prototype, discard what failed
- Incrementally build up features
- Keep reusability in mind
  - generic over customization
  - New ideas take time to generalize and validate





Infor EAM Reporting - Pentaho - CMI QA Equipment: HCQBRDP004-CR000001 Extracted on: 11/10/2022 10:41

#### Electronic MIP for HCQBRDP004-CR000001

#### A - Production Start-up (CMI)

|  | Document                                | Version | Executing Entity                 | Supplier                     | Client          | 3rd Party | Reports/NCRs                                     | Comments   |
|--|---|---------|----------------------------------|------------------------------|-----------------|-----------|--|--|
| A.1 - Prod.Start-Up:Val. parts,calc. margins,assign<br>parts to assembly | Assembly Procedure LHC-<br>QBRD-FP-0004 | 1.1     |                                  | IH JAMIL RIZWAN<br>23-MAY-22 |                 |           | NCR: LHC-QBRDP-QN-0001                           | A. Seller digitally signed on behalf of R. Jamil initially due to access issues<br>with EAM light. R. Jamil has signed the paper copy.<br>Now the access issue has been resolved and signed again by R. Jamil. |
|  |   |         |                                  | B - (                        | Cryostating (CN | II)       | _  |  |
|  | Document                                | Version | Executing Entity                 | Supplier                     | Client          | 3rd Party | Reports/NCRs                                     | Comments   |
| Production step  | Welding Book LHC-QBRD-<br>NOT-0004      | 1       |                                  |                              |                 |           | Doc: LHC-QBRDP-FR-0004<br>NCR: LHC-QBRDP-QN-0007 | A. Seller signed on behalf of M. A. Khedhir who performed the welding<br>inspection on 11/05/2022  |
| B.1 - Installation of Locking Rings                                      | LHCQBRD_0113<br>LHCQBRD_0113            | o       | BARLOW<br>IH GRAEME<br>19-JUL-22 | IH DAVID<br>16-MAY-22        |                 |           | Reports  | Comments   |
| Procedures   | Assembly Procedure LHC-<br>QBRD-FP-0004 | 1.1     | Signa                            | atures                       |                 |           |  |  |
|  | Welding Book LHC-QBRD-<br>NOT-0004      | 1       |                                  | HOUSSAIS                     |                 |           | NCR: LHC-QBRDP-QN-0008                           | DH160522: Welding filler not used for welding upper thermal shield,<br>approved by D.RAMOS. DH170522: A.SELLER signed in place of<br>N.MAROUAN (Welder)  |
| B.2 - Installation of Upper Thermal Shield                               | LHCQBRD_0013<br>LHCQBRD_0113            | o       | IH DOUGLAS<br>17-MAY-22          | IH DAVID<br>17-MAY-22        |                 |           |  |  |
|  | Assembly Procedure LHC-<br>QBRD-FP-0004 | 1.1     |                                  |                              |                 |           |  |  |
| B.3 - Cold Mass and Tooling are Ready for<br>Cryostating                 | Assembly Procedure LHC-<br>QBRD-FP-0004 | 1.1     | BARLOW<br>IH GRAEME              | HOUSSAIS                     |                 |           | NCR: LHC-QBRDP-QN-0003                           |  |
|  |   |         | 17-MAY-22                        | 17-MAY-22                    |                 |           |  |  |
|  | Assembly Procedure LHC-                 | 1.1     | BARLOW                           | HOUSSAIS                     |                 |           |  |  |



Implementatior



| Infor EAM Reporting - Pentaho - CMI QA<br>Equipment: HCQBRDP004-CR000001<br>Estrated on 11/10/2021 1041 | Direct link to step in EAMLight  |                     |
|---|--|---------------------|
| EAM   | Light  | 🛎 mbonora   E       |
|   | 🖻 Work Order 30940380 🖹 SAVE 🕂 NEW 😈 DELETE 🛛 🗇 🗗 🖾 🛅 🖸 🖾 🎘                                    | WSJB26              |
|   | CHECKLISTS 🛟   | ~                   |
| A.1 - Prod.Start-Up:Val. parts,calc. margins,as 🗳   | Hide filled Items  |                     |
| parts to assembly   | Activity 10 - MIP ELEC - B.1 - Installation of Locking Rings                                   | X 🕶                 |
| <b>~</b><br>≅   | 10 — MIP ELEC - B.1 - Installation of Locking Rings  | CREATE FOLLOW-UP WO |
|   | the CQBRDP004-CR000001 − Standard Section D2 Prototype   | ^                   |
| B.1 - Installation of Locking Rings   | Assembly Procedure LHC-QBRD-FP-0004  | 1.1 Ver.            |
|   | LHCQBRD_0113 LHCQBRD_0113  | 0 Ver.              |
|   | Welding Book LHC-QBRD-N0T-0004   | 1 Ver.              |
|   | A. Seller signed on behalf of M. A. Khedhir who performed the welding inspection on 11/05/2022 |                     |
| B.2 - Installation of Upper Thermal Shield  | E-SIGNATURES   | ^                   |
|   | CMI Production Team<br>Graeme Barlow 19-JUL-2022 10:38   | SIGN                |
| B.3 - Cold Mass and Tooling are Ready for<br>Cryostating  | CMI QA Team<br>DAVID HOUSSAIS 16-MAY-2022 11:09  | SIGN                |
|   | Assembly Procedure LHC-<br>1.1 BARLOW HOUSSAIS   |                     |





| Equipment: HCQBRDP004-CR00001<br>Estracted on: 11/10/2022 10:41          |                | Checklists   |                               |
|--|----------------|--|-------------------------------|
|  | <b>_</b> •     | Image: Work Order 31262895         Image: SAVE         + NEW         Image: Black Stress         Image: SAVE         + NEW         Image: Black Stress         Mission         Mission |                               |
|  |                | 20 - D.1 - Test électrique la bobine   |                               |
| A.1 - Prod.Start-Up:Val. parts,calc. margins,assign<br>parts to assembly | Assemble<br>QB | the HCMQXFBC08-CR000128 - MQXFB prototype long coll  | is issues                     |
|  | :=             | Electrical test protocol LHC-MQXFBC+P-0020   |                               |
|  | Do             | Control Procedure LHC-MQXFBC-FP-0057   |                               |
|  | Welding        | Coll manufacturing follow-up file LHC-MQXEBCFP-0014 Ver.   | elding                        |
| B.1 - Installation of Locking Rings                                      |                | Inductance afficuring [10 kHz]   |                               |
|  |                | Arramble   | R[DC](20C') after curing m0hm |
|  | QB             | Inductance aft curing [1 Hz]   |                               |
|  | Welding        | Inductance aff curing [100 Hz]   | eld,                          |
| B.2 - Installation of Upper Thermal Shield                               | LHO            | Inductance aft curing [1kHz]   |                               |
|  | Assembly       | Inductance aft curing [10Hz]   |                               |
|  | QB             | E-SIONATURES   |                               |
| B.3 - Cold Mass and Tooling are Ready for                                | Assembly<br>QB | LMF Production Team SIGN   |                               |
| Lryostating  |                | LMF QA Team SIGN   |                               |
|  | Assembly Proce | 1.1 : BARLOW : HOUSSAIS  |                               |



| CERN Infor EAM Reporting - Pentaho - CMI QA<br>Equipment: HCQBR0P004-CR00001<br>Extracted on: 11/10/2022 10:41 |                  | Digital signatures  |   |      |                     |        |  |  |  |  |
|--|------------------|---|---|------|---------------------|--------|--|--|--|--|
|  | <b>_</b> •       | Work Order 31252295 SAVE + NEW      DELETE      T     Hide filled items | WSJ826  |      |                     |        |  |  |  |  |
|  |                  | 20 — D.1 - Test électrique la bobine                                    |   |      | CREATE FOLLOW-UP WO |        |  |  |  |  |
| A.1 - Prod.Start-Up:Val. parts,calc. margins,assign parts to assembly  | n Assemble<br>QB |   | 🗱 HCMQXFBC08 CR800128 — MQXFB prototype long coll |      |                     |        |  |  |  |  |
|  |                  | Electrical test protocol LHC-MQXFBC-FP-0020                             |   |      | Ver.                |        |  |  |  |  |
|  | Do               | Control Procedure LHC-MQXFBC-FP-0057                                    |   | Ver. |                     |        |  |  |  |  |
|  | Welding<br>N     | Coll manufacturing follow-up file LHC-MQXFBC-FP-0014                    | E-Signature                                       |      | Ver.                | elding |  |  |  |  |
| B.1 - Installation of Locking Rings  | LHO              | Inductance aft curing [10 kHz]  |   |      | mH                  |        |  |  |  |  |
|  | Assembly         | R[DC](20C*) after curing  | Pasword *   |      | mOhm                |        |  |  |  |  |
|  | Welding          | Inductance aft curing [1 Hz]  | CANCEL SIGN                                       |      | mH                  | eld,   |  |  |  |  |
|  | h                | Inductance aft curing [100 Hz]  |   |      | mH                  |        |  |  |  |  |
| B.2 - Installation of Upper Thermal Shield   | LHO              | Inductance aft curing [1KHz]  |   |      |                     |        |  |  |  |  |
|  | Assemble<br>QB   |   |   |      |                     |        |  |  |  |  |
| B.3 - Cold Mass and Tooling are Ready for  | Assembly<br>QB   | E-SIGNATURES  |   |      | SIGN                |        |  |  |  |  |
| Cryostating  |                  | LMF QA Team   |   |      | SIGN                |        |  |  |  |  |
|  | Assembly Proce   | aure LHC- 1.1 BARLOW HOUSSAIS   |   |      |                     |        |  |  |  |  |











Direct link to procedure Infor EAM Reporting - Pentaho - CMI QA CERN Equipment: HCQBRDP004-CR000001 Extracted on: 11/10/2022 10: Electronic MIP for HCQBRDP004-CR000001 Inbox 👻 📴 Caddie Search 2706242 v.1.1 | LHC-QBRD-FP-0004 v.1.1 Released & CERN Internal Assembly Procedure for D2 Prototype QBRD Standard Section 👘 by Ali Seller 🜌 A.1 - Prod.Start-Up:Val. parts,calc. margins,assign \* 8 Assemb parts to assembly Edit Status - Sharenil Info Description External reference: QBRD (D2) Prototype Cryostat Standard Section - WP3 Keywords Details ding Local administrators: List of Administrators Equipment code: LHCQBRD Context: HL-LHC-WP3-EXT Release procedure: HL-AL Context for WP3 with the QA team from bld 180 Fabrication. Assembly and Verification Associated Links: CDN Links: B.1 - Installation of Locking Ring: This page https://edms.cern.ch/document/2706242/1.1 Files 强 Add | 🚘 Delete | 🚘 Download all Per page 10 Size Last modified date Last modified by Name B.2 - Installation of Upper Thermal Shield LHC-QBRD-FP-0004\_v.1.1\_-\_Assembly\_procedure\_of\_D2\_prototype\_02May2022.docx 72.8 MB 2022-05-02 15:29:46 ALISDAIR DOUGLAS SELLER £ LHC-QBRD-FP-0004\_v.1.1\_-\_Assembly\_procedure\_of\_D2\_prototype\_02May2022.pdf 3.2 MB 2022-05-02 15:29:46 ALISDAIR DOUGLAS SELLER 🔰 🖣 Page 1 of 1 🕨 🔰 📿 Assembly Procedure LAC- info B.3 - Cold Mass and Tooling are Ready for OBRD-FP-0004 NCR: LHC-QBRDP-QN-0003 Cryostating 17-MAY-22 17-MAY-22 Assembly Procedure LHC-HOUSSAIS



| Equipment: HCQBRDPO<br>Extracted on: 11/10/2022 10:     | entaho - CMI QA<br>04-CR000001<br>11 |   | Direct link to NCR/Reports  |   |
|---|--------------------------------------|---|---|---|
| /- \  |                                      |   | Image: State of the state o |   |
|   |                                      |   | BF Edit Status -  |   |
| A.1 - Prod.Start-Up:Val. parts,cal<br>parts to assembly | . margins,assign                     | Document<br>Assembly Procedure LHC-<br>QBRD-FP-0004                     | Info     Description: This NO is considered as "NON-CRITICAL" (Level 1) with NC type "Negligible" as described in the TE: Enternal reference:     Keywords: Standard Section D2 Prototype, insulation piece, EHE'H line     Insulation pieces, HOGERO, 103) are not mountable on EHE line of D2 prototype     control is detected the EHE'H line bits and insulation piece when fixed in final position. No limitation     insulation pieces and the output bits of the piece when fixed in final position. No limitation     insulation pieces and the output bits of the piece when fixed in final position. No limitation     insulation pieces and bits output the EHE. If line, when fixed in final position. No limitation     insulation pieces and bits output the EHE_H line.  | ly due to access issues<br>d again by R. Jamil. |
|   |                                      | Document  | Special Properties           Main cause:         Materials           Class:         Mechanical           Disposition / Action:         Repair           Importance / Non orticcal         Non orticcal  | rformed the welding                             |
|   |                                      | Welding Book LHC-QBRD-<br>NOT-0004                                      | Critically:   |   |
| 1 - Installation of Locking Rings                       |                                      | LHCQBRD_0113<br>LHCQBRD_0113<br>Assembly Procedure LHC-<br>QBRD-FP-0004 | Local administrators: Let of Administrators Context: HL-LHO-WP34TF Context: HL-LHO-WP34TF General context for WP3 MTF Associated Links: CDN Links:  |   |
|   |                                      | Welding Book LHC-QBRD-<br>NOT-0004                                      | This page https://edms.cem.ch/document/2754981/2.0     Files  | er thermal shield,<br>d in place of             |
| 3.2 - Installation of Upper Therm                       | al Shield                            | LHCQBRD_0013<br>LHCQBRD_0113  | Mod         imposite         Pe           Name         Size         Last modified date         Last modified date           ■         Available         Size         Last modified date         Last modified date  | r   |
|   |                                      | Assembly Procedure LHC-<br>QBRD-FP-0004                                 |   |   |
| B.3 - Cold Mass and Tooling are F                       | eady for                             | Assembly Procedure LHC-<br>QBRD-FP-0004                                 | More info     Sub-Documents Used In Approval & Comments Access rights Versions History  |   |
| Lryostating   |                                      |   | Create subdocument   Attach document   Detach   Export to Excel   Request access   Add all to Caddie   Edit Tags   Download files 🗹 Hide Obsolete   Per   |   |
|   |                                      | Assembly Procedure LHC-   | I/VI #         Id         ITRe         Price         Status         Created on         Author         Document type         Tags           1.1         BARLOW         HOUSSAIS  |   |





- Reports and KPI
- Summaries

#### **Notifications** [LQXF-LMF] Notification for HCLQXFC001-CR-DUMMY [al. $x \leftarrow ( ) \rightarrow \cdots$ No Reply EAM To Kevin Monneron: Sonia Mallon Americo 11:59 AM Dear. We inform you that a step is to be carried out after step D7- Install CLIQ box (CMI) on the asset HCLOXFC001-CR-DUMMY. Please complete the attached checklist: work order: https://cmmsx.cern.ch/SSO/eamlight/workorder/30133247 You can refer to the Electronic MIP documents for on overview of the production: prod.cern.ch/pentaho/api/repos/:home:CERN:EAM:CMI:MIP\_ELEC\_CMI.prpt/viewer Comment Best regards CMI QA Team

HCMQXFBC08-CR000128 - WorkOrder Planning

| Status - HCM        | ment<br>IQXFBC08-CR000128 -      | _            |        |       |       |        |         |
|---------------------|----------------------------------|--------------|--------|-------|-------|--------|---------|
| FOUIPMENT           | DESC                             | INTERVENTION | ember, | 2022  |       | Octobe | r, 2022 |
| EQUITIVELVI         |                                  |              | 12/09  | 19/09 | 26/09 | 03/10  | 10/10   |
| HCMQXFBC08-CR000128 | Total                            | 8            | _      |       | 8     |        | Toda    |
| HCMQXFBC08-CR000128 | 1 - Production start-up          | 1            | 1      |       |       |        |         |
| HCMQXFBC08-CR000128 | 10 - Inner layer winding         | 1            |        |       | 1     |        |         |
| HCMQXFBC08-CR000128 | 20 - Inner layer curing          | 1            |        |       | 1     |        |         |
| HCMQXFBC08-CR000128 | 30 - Outer layer winding         | 1            |        |       |       | 1      |         |
| HCMQXFBC08-CR000128 | 40 - Outer layer curing          | 1            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 45 - Cable core removal          | 1            |        |       |       |        | 1       |
| HCMQXFBC08-CR000128 | 50 - Electrical tests            | 1            |        |       |       |        | 1       |
| HCMQXFBC08-CR000128 | 60 - Coil validation after windi | 1            |        |       |       |        | 1       |
| HCMQXFBC08-CR000128 | 100 - Reaction                   | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 105 - Reaction Heat Treatmen     | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 110 - Splicing                   | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 120 - Electrical tests during re | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 130 - Impregnation               | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 135 - Impregnation report        | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 140 - Geometrical measureme      | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 150 - Final electrical tests     | 0            |        |       |       |        |         |
| HCMQXFBC08-CR000128 | 160 - Impregnated coil accept    | 0            |        |       |       |        |         |

#### MQXFB Coils Manufacturing



#### **MQXFB** Coils Status





mplementation



- Involved EAM components
- Access rights
- Procedure and tools





- Starting point: approved MIP (EDMS) + procedures, drawings
- Equipment + Item in EDMS





- Standard Workorders
  - Workorder templates
  - Equal to MTF step

| A - Production | Start-up | (CMI) |
|----------------|----------|-------|
|----------------|----------|-------|

|  |                  | Document                                | Version | Executing Entity | Supplier                     | Client | 3rd Party | Reports/NCRs           | Comments   |
|--|------------------|---|---------|------------------|------------------------------|--------|-----------|------------------------|--|
| A.1 - Prod.Start-Up:Val. parts,cald<br>parts to assembly | . margins,assign | Assembly Procedure LHC-<br>QBRD-FP-0004 | 11      |                  | IH JAMIL RIZWAN<br>23-MAY-22 |        |           | NCR: LHC-QBRDP-QN-0001 | A. Seller digitally signed on behalf of R. Jamil initially due to access issues<br>with EAM light. R. Jamil has signed the paper copy.<br>Now the access issue has been resolved and signed again by R. Jamil. |





Taskplans \_\_\_\_\_

|   |  |   |         |                  | A - Prod                     | uction Start-up |           |                        |  |
|---|--|---|---------|------------------|------------------------------|-----------------|-----------|------------------------|--|
|   |  | Document                                | Version | Executing Entity | Supplier                     | Client          | 3rd Party | Reports/NCRs           | Comments   |
| • | A.1 - Prod.Start-Up:Val. parts,calc. margins,assign<br>parts to assembly | Assembly Procedure LHC-<br>QBRD-FP-0004 | 11      |                  | IH JAMIL RIZWAN<br>23-MAY-22 |                 |           | NCR: LHC-QBRDP-QN-0001 | A. Seller digitally signed on behalf of R. Jamil initially due to access issues<br>with EAM light. R. Jamil has signed the paper copy.<br>Now the access issue has been resolved and signed again by R. Jamil. |

- Activity templates
- Signing rights (groups)
- Notifications
- Workorder logic





- Checklists
  - Procedures



- Input fields
- Link to custom fields
  - MTF equipment data

| IC3 after ILC   | mm |
|---|----|
| IR3 after ILC   | mm |
| Gap btw. poles after ILC  | mm |
| IC3 after ILC IR3 after ILC IR2 after ILC IR2 after ILC IC4 after ILC | mm |
| IC4 after ILC   | mm |





# eMIP Creation in Practice

- 1. Fill out Excel Sheet
  - Defaults
  - Steps
  - Checklists
- 2. Generated import tables
- 3. Few manual adjustments
- 4. Checked by link person
- 5. CERN Upload Utility
- 6. Assign workflow in Equipment Generator

| A   | B   | c  | D        | E        |       |
|-----|---|--|----------|----------|-------|
| 2   | Activity                                      | EDMS documents (comma separated)   | Executin | ç Suppli | ier C |
|     | Démarrage de la production                    | MPLHC-M0PFBC-FP-0047, Control Proceedure LHC-M0PFBC-FP-0056  |          | IH/R     | H     |
|     | Véril d.I. conf. des tourets au Inst. sur la  |  |          |          |       |
|     | hoh a d issuente pâler                        | Vanders Research and HC-MOVERC-ER-0001 Control Research and HC-MOVERC-ER-0057  |          | 14       | - 14  |
|     | bob. e.u. jeux enne poles                     | What is the main best in the second s |          |          |       |
|     | L   | whang Procedure LRL-MLAP BL-TP-0U0 LL-MAP BL-TP-0U0 LL-MAP BL-TP-0U0 CINetayer Procedure LRL-MLAP BL-TP-0U0 CINetayer Isonoaton Robor-Op Re LRL-PLAP BL-TP-0U0 CINEtayer Isonoaton   |          |          |       |
|     | Préparation des composants                    | manufacturing follow-up file LHC- MQXFBC-FP+0014   | H        | H/R      |       |
|     | Feu vert pour commencer le bobinage           |  |          |          |       |
| )   | couche interne                                | Charakite LHC-MCXFRC-FP-0044 Control Procedure LHC-MCXFRC-FP-0057  | H        | H/B      |       |
|     |   |  |          |          |       |
|     | - · · · · · · · ·                             |  |          |          |       |
|     | Bobinage de la couche interne                 | Winding Procedure LHC+MUX2 BC+P+-0001, Control Procedure LHC+MUX2 BC+P+-0057, Coll manufacturing follow-up file LHC+MUX2 BC+P+-004, Coll Ltaving LHCMUX2 BC+-004, Coll L |          | PVH      |       |
| 2   | Polymérisation de la couche interne           | Winding Procedure LHC-MQXFBC-FP-0001,Polymerization Procedure LHC-MQXFBC-FP-0011, Control Procedure LHC-MQXFBC-FP-0057, Coll manufacturing follow-up file LHC-MQXFBC-FP-0014   |          | IH/R     |       |
|     | Feu vert pour commencer le bobinage de la     |  |          |          |       |
| 3.0 | couche externe                                | Checklist LHC-MCXFBC-FP-0044   | H        |          |       |
|     |   |  |          |          |       |
|     | Balances de la construcción de                | Line of the New York Control of the  |          | 1.07     |       |
| 3   | Dobinage de la coucrie externe                | whang Procedure LHL-HILAR BL-FP-000 (London Procedure LHL-HILAR BL-FP-005 (Lon manufacturing follow- up file LHL-HILAR BL-FP-004), Loi Linaving LHL-HILAR BL-1003 (  |          | INH      |       |
| ł   | Polymérisation de la couche externe           | Winding Procedure LHC-MQRFBC-FP-000LPolymeitzation Procedure LHC-MQRFBC-FP-0011, Control Procedure LHC-MQRFBC-FP-0057, Colimanufacturing follow-up file LHC-MQRFBC-FP-0014   |          | H/R      |       |
|     | Enlèvement de l'âme des câbles et mise à      |  |          |          |       |
| 5   | longuese des câbles                           | Vending Proceedure LHC-MDXFBC-FP-0001 Control Proceedure LHC-MDXFBC-FP-0057 Coll manufacturing follow-up file LHC-MDXFBC-FP-0034   | H        | H .      |       |
|     | Test directions is behind                     | Variang Protection in Protection and the second sec | 14       | P        |       |
|     | resi elevisque la sudifie                     | What groweness a scheme och move destroyers and the second scheme to be and the second scheme to be and the second scheme and the second s   |          | F1       |       |
|     | Controle et acceptation de la bobine          | LontolProcedure LHL-MLRP BU-th-MUD /   |          | evR      |       |
|     | Autorisation de l'ingénieur proj. pour        |  |          |          |       |
|     | commencer la prép. pour la réaction           | Reaction Procedure LHC- MQXFBC-FP-0015.Control Procedure LHC-MQXFBC-FP-0059  |          | B        |       |
|     | Evénaration de Poutil de réaction et mine en  |  |          |          |       |
|     | along data babias                             | Description Provide Aug. Market Rev. 0055 Control Rev. Market Rev. 0055 Elevated and an annual Mich. Market Rev. 0054 Color and Aug. Market Rev. 0014  |          |          |       |
|     | prace de la poorrie                           | reason moreous choring room moreous contraint cost and room more set protocol Choring PDC+PH-0000, Coll manufacturing follow-opine Choring PDC+PH-0010   | 11       |          |       |
|     | Prép. de la couche externe et assemblage      |  |          |          |       |
|     | de la partie supérieure du moule              | Reaction Procedure LHC-MQXFBC-FP-0015, Control Procedure LHC-MQXFBC-FP-0059, Electrical test protocol LHC-MQXFBC-FR-0040, Coll manufacturing follow-up file LHC-MQXFBC-FP-0014   | H        | H        |       |
| .0  | Feuvert pour lancer le cycle de réaction      | Reaction fumace manual EDMS 1851714. Checklist for GERCI long fumace LHC-MCINFBC-FP-0063 Control Procedure LHC-MCINFBC-FP-0059   |          | B        |       |
| _   | Bearting                                      | Resister Droads val HCs MOVERC-ED-0005 Control Droads val HC-MOVERC-ED-0059 Col manufacturing following file LHC-MOVERC-ED-0014  |          | P        |       |
|     | An elizar de suels de elization               | Develop Technick Company Co  |          | 0        |       |
|     | Analyse du cycle de leaction                  | Preston Procedure LPL * May DC * P*0015 Control Procedure LPL * May DC * P*0050  |          | n        |       |
|     | Démontage du carcan de réaction               | Splicing Procedure LHC-MQXFBC-FP-0018, Control Procedure LHC-MQXFBC-FP-0058, Impregnation follow-up Ne LHC-MQXFBC-FP-0037  | H        | R        |       |
|     | Joints électriques et mise en place des       |  |          |          |       |
|     | neises de notentiel                           | Solicine Procedure J HC- MOXERC-FP-0008 Control Procedure J HC-MOXERC-FP-0058 Solicine follows in Na J HC-MOXERC-FP-0035 Interconation follows in Na J HC-MOXERC-FP-0037   |          | H .      |       |
|     | Contrille de Tradation des joints électriques | Solving December 1 MC - MOVED - FD- OVE Council December 1 MC - MOVED - FD- 0050 Intersection (allow on Fig. 1 MC - MOVED - FD- 0017   |          | 14       |       |
|     | Controle de l'isolation des joins electriques | Spicing Procedure Lnum Plan Pour Provide Lnum Lnum Pour Phase Provide Annual Phase P |          |          |       |
| 1   | Préparation de la couche externe              | Preparation for impregnation Procedure LHC-MCXPBC+PP-0007, Control Procedure LHC-MCXPBC+PP-0000, Electrical test protocole LHC-MCXPBC+PP-0023, Impregnation follow-up file LHC-MCXPBC+PP-0037.   | IH .     | н        |       |
| 2   | Préparation de la couche interne              | Preparation for impregnation Procedure LHC-MQXFBC-FP-0017, Control Procedure LHC-MQXFBC-FP-0060, Coll manufacturing follow-up file LHC-MQXFBC-FP-0014, Impregnation follow-up file   | I H      | R        |       |
| 3   | Tests électriques après fermeture du moule    | Preparation for impregnation Procedure LHC-MOXFBC-FP-0017. Control Procedure LHC-MOXFBC-FP-0050. Electrical text protocol LHC-MOXFBC-FP-0031. Impregnation follow-up file LHC-MOXFBC-FP-0037   | H        | R        |       |
|     | Validation de la fermeture du moule locurale  |  |          |          |       |
|     | Valuation de la remiendre domicale (coopre    |  |          |          |       |
| 4   | de senage, rune ou nicute)                    | reparation of impregnation reduced as the result (cannot reduce a contrary control in reducing register reducing results) and results  |          | n        |       |
|     | Préparation machine d'imprégnation et         |  |          |          |       |
| 3   | Cycle d'Imprégnation                          | Injection system impregnation protocol LHC-MQXFBC-FP-0088/mpregnation follow-up file LHC-MQXFBC-FP-0037, Control Procedure LHC-MQXFBC-FP-0080  | H        | R        |       |
| 7   | Analuse du cucle d'imprégnation               | Analysis procedure LHC-MDXFBC-FP-0091  |          | B        |       |
| 9   | Démontante du moule d'imprécipation           | Pressuation for immemation Proceedure LHC-MOXFRC-FR-0017 Control Proceedure LHC-MOXFRC-FR-0010 Immemation follow-up file LHC-MOXFRC-FR-0017  | H        | H.       |       |
| 10  | Manager                                       | Manakaran dari be MOVER ED 0000 Complementari be MOVERC ED 0000  |          | 0        |       |
| 10  | Presures Cercineoriques                       | Previde gy procedure chuming in pum results and resolute chuming in pum resolute chuming in procedure chuming in pum resolute  | 11       | <u>n</u> |       |
| 11  | Tests électriques linaux                      | Control Procedure LHC-MLPP BC-PP-0060,Electrical test protocol LHC-PMLPP BC-PP-0028  | PI       | н        |       |
| 12  | Acceptation de la bobine imprégnée            | Control Procedure LHC-MQXFBC-FP-0060   |          | R        |       |
|     |   |  |          |          |       |
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# In Case of Changes

- Modify Standard WO/Taskplans
- Existing eMIP not touched
- Only future Assets affected
- Changes in already created eMIP possible
  - Only affects specific eMIP
- Direct modification of structure
   -> Made by link person
- Procedure/Document Update transparent (over EDMS version)
- Access rights for signing transparent (not bound to eMIP directly)



## **User Access Control**

- Signing Rights linked to groups
  - M-CMI-P -> Production team of CMI
  - Linked to e-group
- Badge access linked to e-groups





## **Current State**

- Current implementation in use for assemblies (D2 proto cryostat, Q2b cryostat, MQXFB coils and Magnets)
- Tested viability of different scenarios
  - Creating new eMIP from MIP template
  - modifying prototype eMIP to production eMIP
  - Adapting already created assets to eMIP
- Slowly adding features bit by bit in production
  - Quick reaction in case of problems
  - Clear source of new problems



## Outlook

- Simplify inputs
  - Interface for creating new eMIP
  - Input for notifications and recipients
- Extend automatic reports
  - Automatic generation on specific events
  - Summary reports
- Open for everyone
  - Same structure easily adapted to other processes
  - Mutual benefit of EN-IM developments
  - Central place for overview/statistics/information (EAM)



# **Outlook – Operation**

- eMIP managed by QA teams
  - Creation of new eMIP
  - Asset generation
  - Managing of access rights
- Link person
  - For issues and new features
  - Final check of eMIPs (structure, new features, improvements)
  - Coordination with EN-IM team
  - Collection and feasibility check of required features



### Thanks

- Promoted by group (TE-MSC GL) and TE-MSC QA team (pushing initiative)
- CMI and LMF production teams for their patience, help and inputs
- EN-IM team for their quick response and effective help to adopt solutions

